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1-1761024



Memory Sockets

Always EU RoHS/ELV Compliant (Statement of Compliance

Product Highlights:

- DIMM
 - Gold Flash Contact Mating Area
- Plating Number of Positions = 240
- DRAM Type = Double Data Rate (DDR) II, Fully Buffered
- DRAM Voltage = 1.8 V

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Documentation & Additional Information

Product Drawings:

SOCKET ASSEMBLY, VERTICAL FB DIMM, SOLDER TAIL, 240 (PDF, English)

Catalog Pages/Data Sheets:

None Available

Product Specifications:

? Fully Buffered and DDR3 DIMM Soldertail Sockets (PDF, English)

Application Specifications:

Fully Buffered (FB) Dual In -Line Memory Module (DIMM... (PDF,

Instruction Sheets:

? None Available

CAD Files: (CAD Format & Compression Information

- 2D Drawing (DXF, Version B)
- ? 3D Model (IGES, Version B)
- ? 3D Model (STEP, Version B)

List all Documents

Additional Information:

? Product Line Information

Related Products:

? Tooling

Product Features (Please use the Product Drawing for all design activity)

Product Type Features:

- ? Product Type = DIMM
- ? Number of Positions = 240
- DRAM Type = Double Data Rate (DDR) II, Fully Buffered
- ? Module Orientation = Vertical
- ? PCB Retention Feature = Yes

Mechanical Attachment:

- ? Center Retention Hole Diameter (mm [in]) 1.80 [0.070]
- ? Keying = Standard

Electrical Characteristics:

? DRAM Voltage = 1.8 V

Termination Related Features:

- Termination (Solder) Post Length (mm [in])
- Solder Tail Contact Plating = Matte Tin over Nickel

Body Related Features:

- ? Row-to-Row Spacing (mm [in]) = 1.90 [0.075]
- ? Centerline (mm [in]) = 1.00 [0.039]
- ? Number of Rows = Dual
- ? Ejector Type = Standard
- ? Ejector Location = Both Ends
- ? Center Post = With
- ? Number of Keys = 1
- ? Socket Type = Solder Tail
- PCB Retention Method = Boardlock(s)

Contact Related Features:

- Contact Mating Area Plating = Gold Flash
- Contact Mount = Thru Hole
- Contact Material = Copper Alloy
- ? Retention Post(s) Location = Both Ends

Housing Related Features:

- Housing Material = Nylon High Temp.
- ? Housing Color = Black
- ? Housing Flammability Rating = UL 94V -0

Configuration Related Features:

- Insertion Style = Direct Insert
- ? Center Key (mm [in]) = Center

Industry Standards:

- RoHS/ELV Compliance = RoHS compliant, ELV compliant
- <u>Lead Free Solder Processes</u> = Wave solder capable to 240°C
- RoHS/ELV Compliance History = Always was RoHS compliant

Operation/Application:

? Application Type = DDR SDRAM

Packaging Related Features:

Packaging Method = Tray

Other:

Prand = Tyco Electronics